

VC3535VGBMFN1 Datasheet

iC LED Series (L* W*H): 3.5*3.4*1.47mm



Applications

- Telecommunication, office automation, home appliances, industrial equipment
- Full-color strip

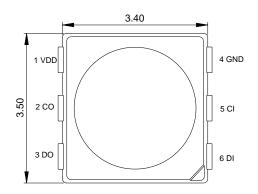
- Consumer electronics
- Other applications

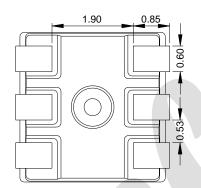
Features

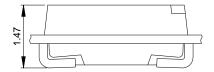
- Serial data transmission signal by (DATA CLK) two line.
- RGB and driver chip are integrated in a package, to form a complete control of pixel point with constant current.
- One pixel contains R, G, and B color that each can achieve 256 level brightness grayscale, which forms 16, 777, 216 combination colors.
- Supports sleep /wake-up mode. In sleep mode, the LED's current was lower than 5uA
- Lens color: White diffused
- RoHS2.0 and REACH-compliant
- ESD level 6kV(HBM)
- Preconditioning: accelerate to JEDEC level 3
- Typical view angle 50% lv:120°
- Reliability Test: AEC Q-102/AEC Q100qualified



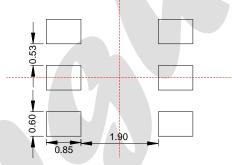
Dimensional Drawing







Recommended Solder Pad



- Dimensions are in millimeters. 1.
- 2. General tolerance is ± 0.1mm.

No.	Symbol	Function description
1	VDD	Supply voltage
2	СО	Clock output
3	DO	Data output
4	GND	Ground
5	CI	Clock input
6	DI	Data input



Naming Rule

VC-3535-VGB-M-F-N1

VC	3535	VGB	M	F	N1
Туре	Package Size	Color	Lens color	Output current	Serial number
		V:red			
VC: With IC Series	3535: 3.5*3.4mm	G:green	M:White diffused	F:20mA	N1: Serial number
		B:blue			

Maximum Ratings

T_A: 25 °C

Parameter	Symbol		Values		Unit
IC Power Supply Voltage	VDD	< 6.5			V
LED voltage	V led	4.5-5.5			V
Rate of data signal	FCLK	15			MHZ
The max led output Current	IOMAX	20 / channel			mA
Thermal Resistance Junction/ Solder Point	RTHJ-S	R 65	G 110	B 100	°C /W
Power dissipation;	PD	<400			mW
IC Power Supply Voltage	VDD	< 6.5			V
Soldering temperature	T _{SD}	260			°C

^{1.} The maximum of soldering time is 10 seconds in $T_{\text{SD.}}$



Characteristics

VDD:5V | TA: 25 °C

Characteristics	Symbol		Min.	Тур.	Max.	Unit	Test condition	
		R	370	460	570			
Luminous Intensity	lv	G	1520	1900	2380	mcd	VDD=5V	
		В	270	330	410			
Dominant Wavelength	λd	R	630	-	636		VDD=5V	
		G	524	-	529	nm		
		В	455	-	460			
View Angle	2θ1/2		-	120	-	deg	VDD=5V	

- 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
- 2. 201/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength, λd is derived from CIE chromaticity diagram and represents the single wavelength which defines the color of the device. Peak Emission Wavelength Tolerance is ± 1 nm.



Bin groups

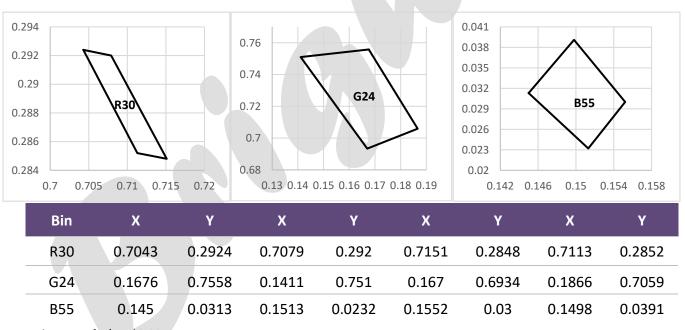
1. Luminous Intensity

VDD:5V | IF: 20mA

Bin C	Code	Min. IV (mcd)	Max. IV (mcd)
V	1	370	460
V -	2	460	570
	1	1520	1900
G -	2	1900	2380
D	1	270	330
В -	2	330	410

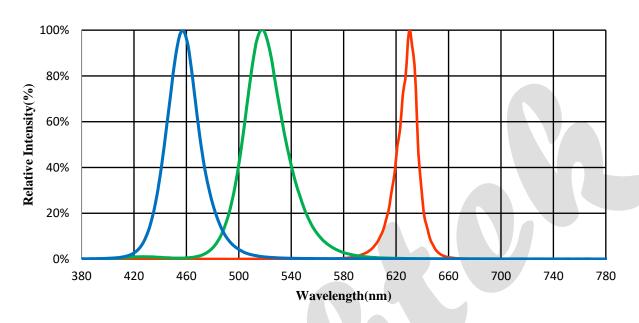
2. Chromaticity Coordinate Groups

VDD:5V | IF: 20mA

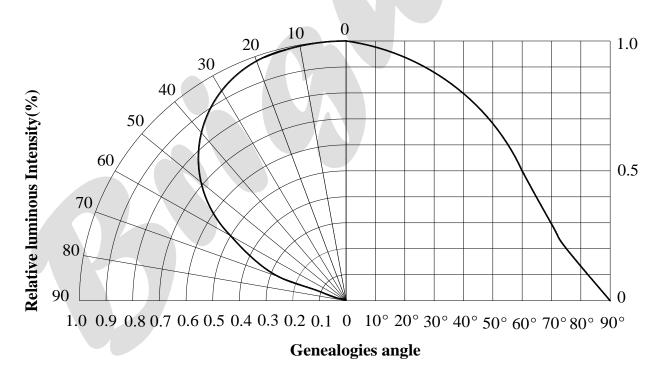


Tolerance of $X/Y : \pm 0.005$

Relative Spectral Power Distribution

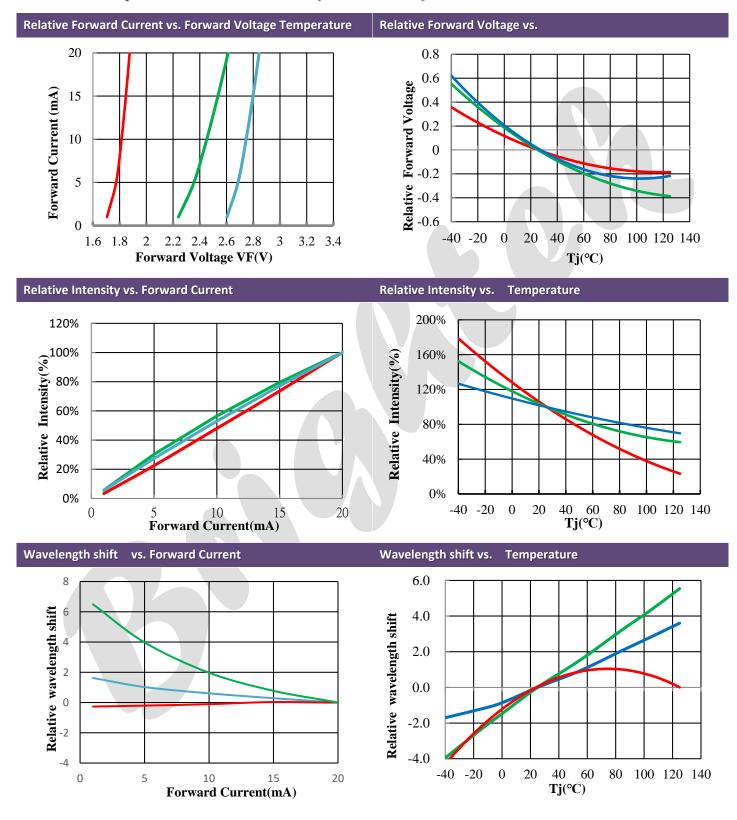


Typical Diagram Characteristics of Radiation





Electronic-Optical Characteristics (Full PWM)



Electrical Characteristics (Ta=25°C;VDD=5V)

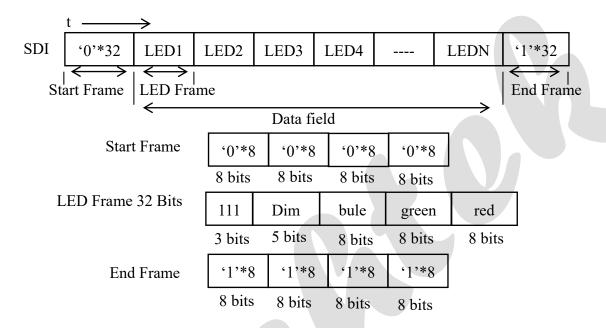
Characteristics	Symbol	Condition	Min.	Тур.	Max.	Unit
Supply voltage	VDD		4.5	5.0	5.5	V
Input high voltage	VIH		2.7	-	VDD+0.4	V
Input low voltage	VIL		-0.4	-	1.0	V
The clock high level width	TCLKH		30	-	-	ns
The clock low level width	TCLKL		30	-		ns
Data set up time	TSETUP		10	- (-	ns
Data hold time	THOLD		5	-	1/-	ns
Working current(IC)	IDD	I out= "OFF"	-	-	2	mA
Static current	I sleep	Sleep mold			5	uA



Function description

1. Series data structure

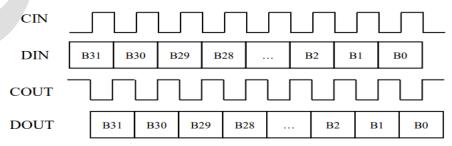
Tandem N-LED



1.1 Dim 5-Bit (level 32) brightness adjustment (simultaneous control of OUTR\OUTG\OUTB three port current)

Data MSB←→LSB	Driving Current
00000	0/31
00001	1/31
00010	2/31
11110	30/31
11111	31/31(max)

1.2PWM input/output signals relations



Function description

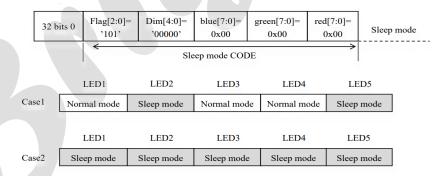
Data MSB	Duty Cycle
0000000	0/255(min)
0000001	1/255
0000010	2/255
11111101	253/255
11111110	254/255
1111111	255/255(max)

1. Sleep and power saving mode

LED supports the sleep/wake-up modes for power-saving purpose. After the IC receives 24-bit 0's BGR data (that is BLUE[7:0]=8h00, G[7:0]=8h00, R[7:0]=8h00), in the meantime, both of the data in 3-bits flag and 5-bits DIMMING is 8h' A0' (that is FLAG[2:0] =3b101 and DIMMING [4:0] =5b00000), the IC will enter sleep mode, its current is about 1uA.

The IC will wake up from sleep mode once receiving the new data with the data of Flag[2:0].

DIMMING [4:0] is not 8h"A0"; after wake-up, all sleeping circuits in IC return to normal working mode within1ms. Since it takes 1ms for a sleeping IC returning to normal function mode, it is recommended for a host to wait for 1ms to send display data and command after issuing a wakeup command

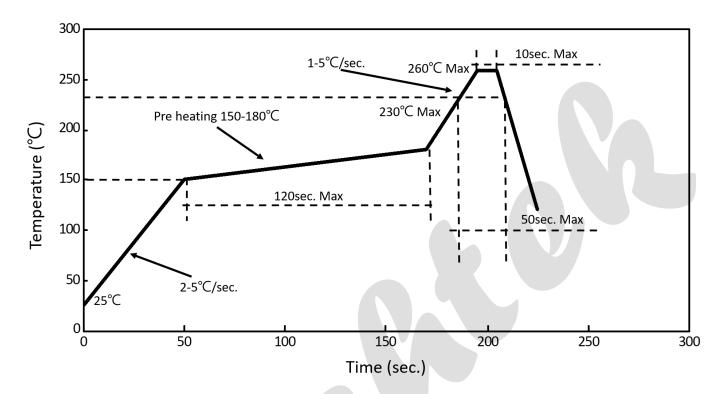


In case 1, while lamp2 is under sleep mode, in the following data transfer process, the state of lamp 2 will be not changed as long as the 32 bits data for lamp 2 is received with data of

Flag[2:0] DIMMING[4:0] being 8h"A0". It means lamp2 will keep in sleep mode as well. In the situation, lamp2 can pass through the remaining data to lamp 3 (32bits) to change the display data of lamp 3. In other words, the sleeping chip is able to pass the data to the next chips.



Reflow Soldering Profile

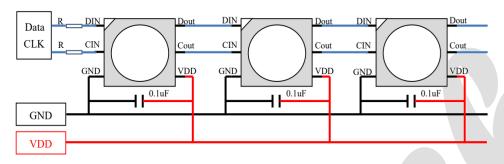


- We recommend the reflow temperature 240°C (± 5 °C).the maximum soldering temperature should be limited to 260°C. 1.
- Do not stress the silicone resin while it is exposed to high temperature. 2.
- 3. The reflow process should not exceed 3 times.



Test Circuit and Precautions for User

1. Typical application circuit



Notes:

When the first LED is connected to the MCU, a resistance R is needed in series between its signal input line and the MCU. The size of R depends on the number of cascade beads. The more cascades, the smaller resistance R is used. It is generally recommended that the value be between 100-1K. Usually the recommended value is around 300 R. In order to make the LEDs work more stably, a parallel capacitor is needed between VDD and GND of each.

2. Handling precautions

2.1 Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2.2 Storage

- ① It is recommended to store the products in the following conditions:
 - Humidity: 60% R.H. Max.
 - Temperature: 5° C ~30 $^{\circ}$ C (41 $^{\circ}$ F ~86 $^{\circ}$ F)
- ② Shelf life in sealed bag: 12 month at $<5^{\circ}$ C \sim 30 $^{\circ}$ C and <60% R.H. after the package is Opened, the products should be used within 1 week or they should be keeping to stored at $\leq 20\%$ R.H. with zip-lock sealed.

2.3 Baking

Suggest packing open after 1 week, before use baking products, conditions as follows:

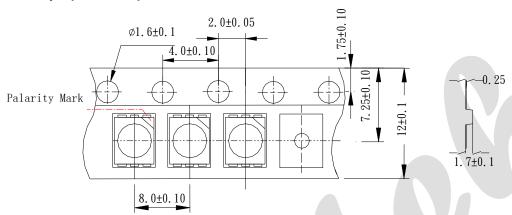
- ① 60±3°C X 6hrs and < 5%RH, for reel
- 125±3°C X 2hrs, for single LED

It shall be normal to see slight color fading of carrier (light yellow) after baking in process.

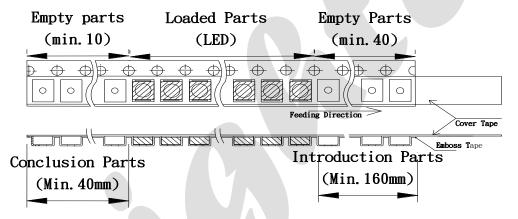


Tapping

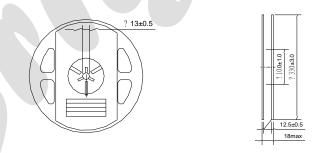
1. Dimensions of Tape (Unit: mm)



2. Arrangement of Tape



3. Dimensions of Reel (Unit: mm)



Note: 01.The tolerance unless mentioned is ±0.2mm. 02.The measured unit is "mm".

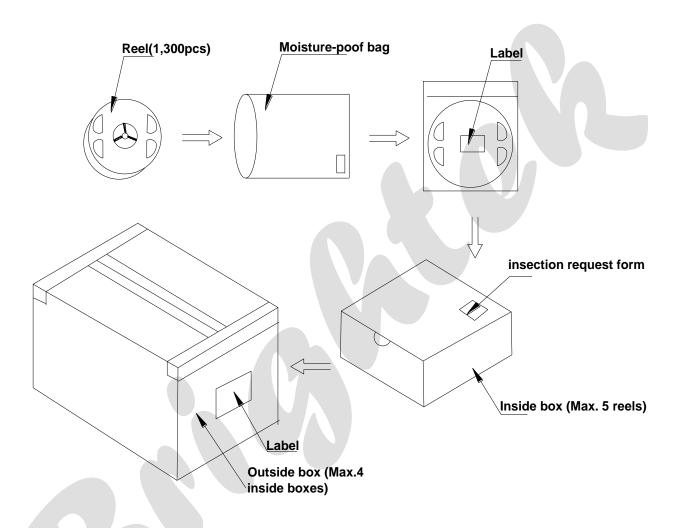
Notes:

- 1. Empty component pockets are sealed with top cover tape
- 2. The max loss number of SMD is 2pcs
- 3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications
- 4. 1,300pcs per reel
- 5. The remainder packing in multiples of 500pcs.



Packing

Packaging Specifications



Reeled product (max.1,300) is packed in a sealed moisture-proof bag. Five bags are packed in an inner box (size: about 260 X 230 X 100 mm) and four inner boxes are in an outer box (size: about 480 X 275 X 215 mm). On the label of moisture-poof bag, there should be the information of Part No., Lot No. and quantity number; also the total quantity number should be on inspection request form on outer box.



Precautions

1. Abnormal situation caused by improper setting of collet

To choose the right collet is the key issue in improving the product's quality. LED is different from other electronic components, which is not only about electrical output but also for optical output. This characteristic made LED more fragile in the process of SMT. If the collet's lowering down height is not well set, it will bring damage to the gold wire at the time of collet's picking up and loading which will cause the LED fail to light up, light up now and then or other quality problems.

2. How to choose the collet

During SMT, please choose the collet that has larger outer diameter than the lighting area of lens, in case that improper position of collet will damage the gold wire inside the LED. Different collets fit for different products, please refer to the following pictures cross out.

Outer diameter of collet should be larger than the lighting area



3. Other points for attention

- No pressure should be exerted to the epoxy shell of the SMD under high temperature.
- Do not scratch or wipe the lens since the lens and gold wire inside are rather fragile and cross out easy to break.
- CLED should be used as soon as possible when being taken out of the original package, and should be stored in anti-moisture and anti-ESD package.
- This usage and handling instruction is only for your reference. 4.



Disclaimer

- Brightek reserves the right(s) on the adjustment of product material mix for the specification.
- The product meets Brightek published specification for a period of one year from date of shipment.
- The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
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